

8

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6

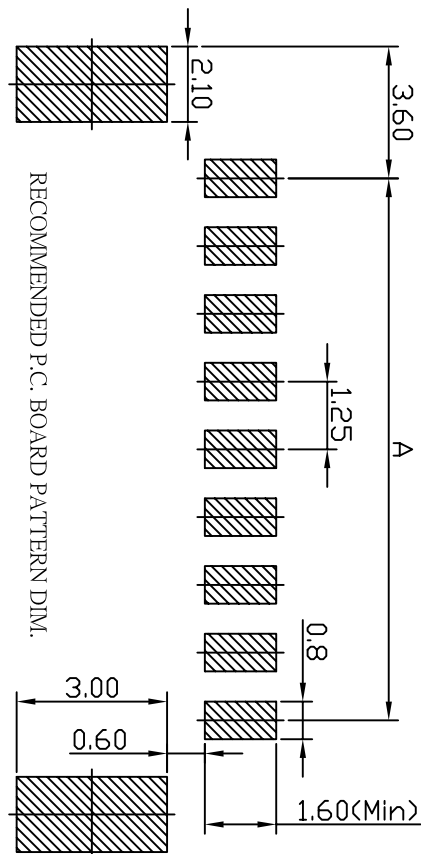
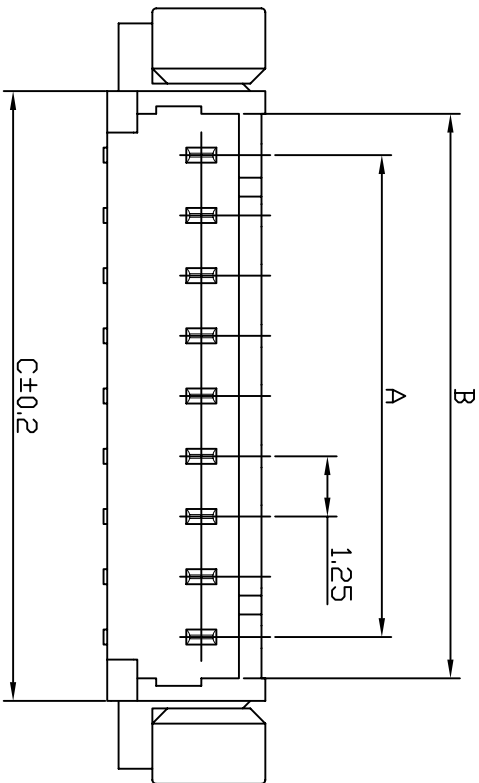
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4

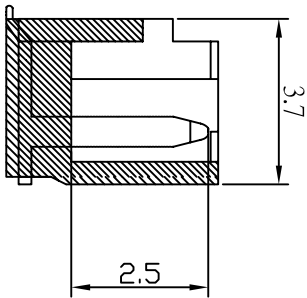
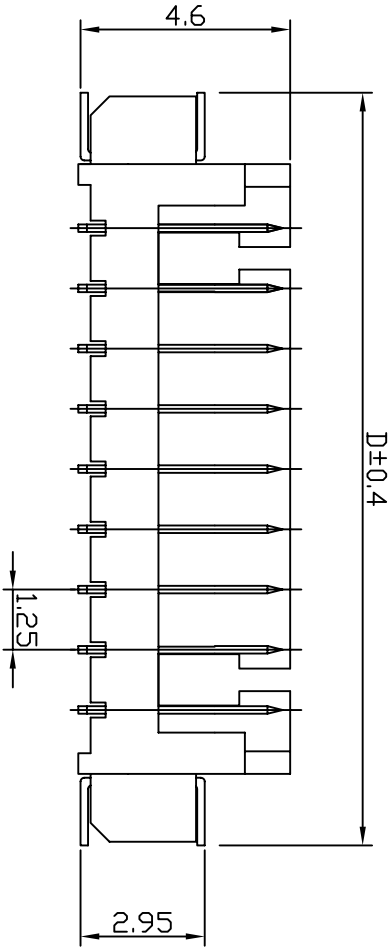
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2

1



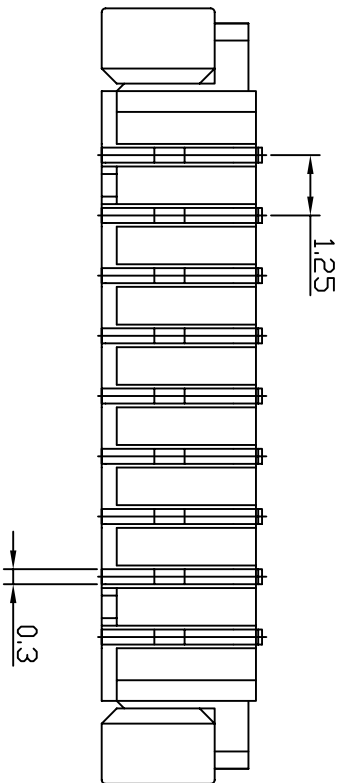
RECOMMENDED P.C. BOARD PATTERN DIM.



MATERIAL:

WAFER:HIGH TEMPERATURE PLASTIC
NYLON46 UL94V-0
PIN:HIGH STRENGTH BRASS
WITH TIN OVER NICKEL PLATED

CKT.	A	B	C	D
2	1.25	3.05	4.25	7.65
3	2.50	4.30	5.50	8.90
4	3.75	5.55	6.75	10.15
5	5.00	6.80	8.00	11.40
6	6.25	8.05	9.25	12.65
7	7.50	9.30	10.50	13.90
8	8.75	10.55	11.75	15.15
9	10.00	11.80	13.00	16.40
10	11.25	13.05	14.25	17.65
11	12.50	14.30	15.50	18.90
12	13.75	15.55	16.75	20.15
13	15.00	16.80	18.00	21.40
14	16.25	18.05	19.25	22.65
15	17.50	19.30	20.50	23.90



LTN	Description	DR	CHK	Date
01	修改膠帶尺寸及外型			01/08/19
02	修改端子外型			01/08/19

純通有限公司

Name: WIRE TO BOARD 1.25mm WAFER SMT V/T

Drawing No.

General Tolerances:		Unit:	Scale:	DR:	CHK:	APPD:
X.XX	± 0.15	mm	ROM	Kathy Wang	Milder Hsieh	C.Y. Liao
X.X	± 0.25					